

FrelTec

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Germany

Bridge Rectifier
MBS

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FrelTec Bridge Rectifier

SPECIFICATION

68A	MB_____xxxxx	MBSX	L03
Type	Type	Package	Packing
68A: Bridge Rectifier	MB_____	MBS	L03: tape and Reel(embossed tape) for 3000 pc (13'reel)

All products according to RoHS (2015/863/EU)

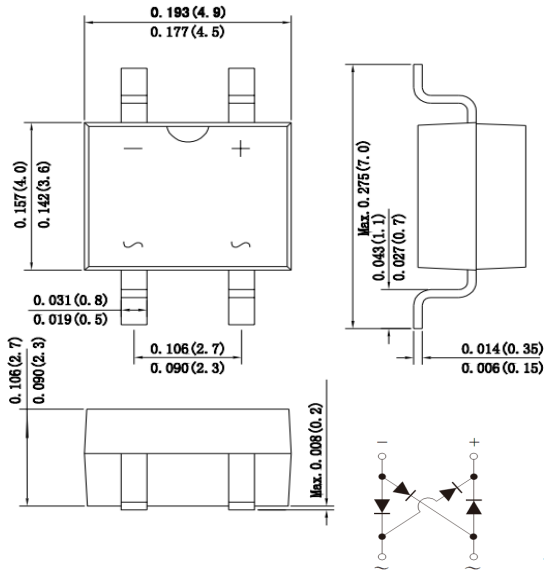
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Bridge Rectifier

MB05S thru MB10S

PACKAGE OUTLINE



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Maximum Ratings & Characteristics

Ratings at 25°C ambient temperature unless otherwise specified,

FrelTec Bridge Rectifier

Parameter	SYMBOLS	MB05S	MB1S	MB2S	MB4S	MB6S	MB8S	MB10S	UNITS
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	V
Maximum average forward rectified current at $T_L=100$ C On glass-epoxy P.C.B (Note 1)	$I_{(AV)}$	1,0							A
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I_{FSM}	35,0							A
Rating for fusing ($t=8.3$ ms, $T_a=25^\circ$ C)	I_t^2	5,08							A ² s
Maximum instantaneous forward voltage at 1.0A	V_F	1,0							V
Maximum DC reverse current $T_A=25^\circ$ C at rated DC blocking voltage $T_A=125^\circ$ C	I_R	2,0 200							μ A
Typical junction capacitance (Note 2)	C_J	18,0							pF
Typical thermal resistance	$R_{\theta JA}$	72,0							$^\circ$ C/W
Operating junction and storage temperature range	T_J, T_{STG}	-55 to +150							$^\circ$ C

Note:1.Mounted on glass epoxy PC board with 1.3*1.3mm solder pad 2.Measured at 1MHz and applied reverse voltage of 4.0V D.C.

FIG. 1- DERATING CURVE OUTPUT RECTIFIED CURRENT

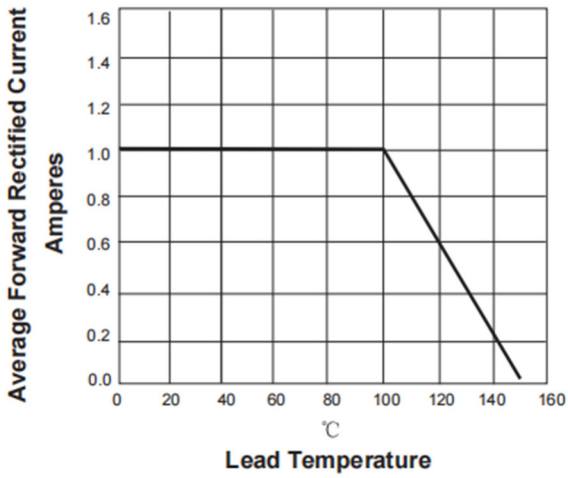


FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT PERLEG

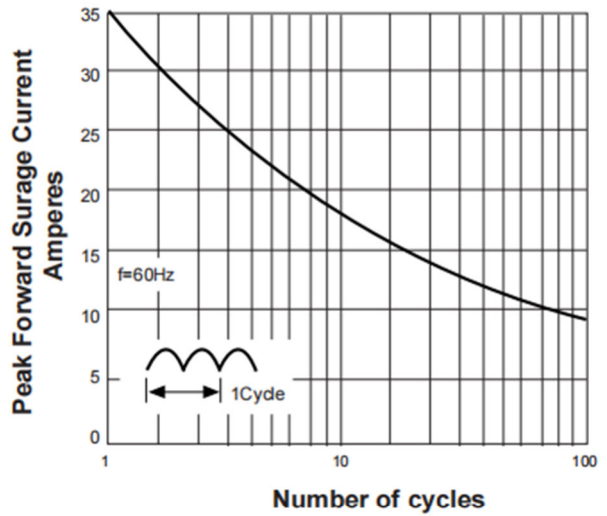


FIG. 3-TYPICAL FORWARD VOLTAGE CHARACTERISTICS

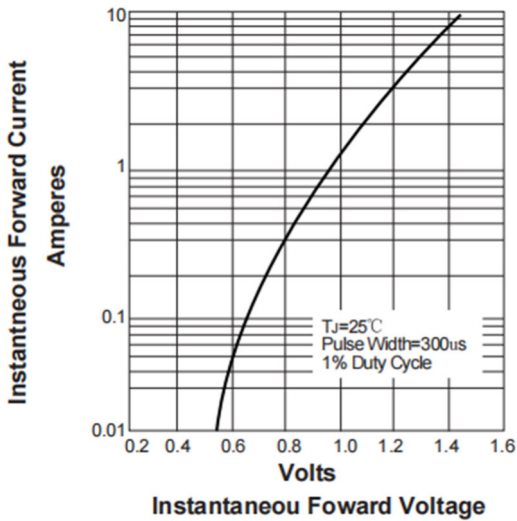
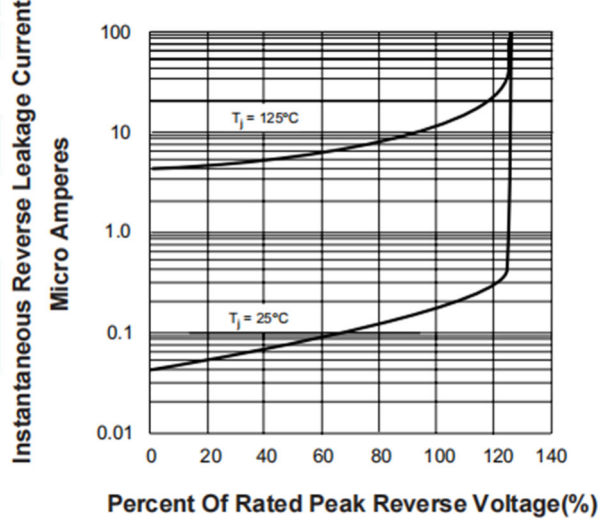
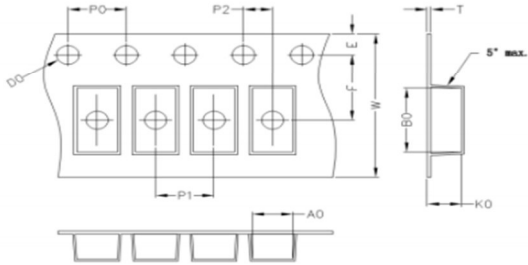


FIG. 4-TYPICAL REVERSE LEAKAGE CHARACTERISTICS



Package Information

Carrier Dimension(mm)

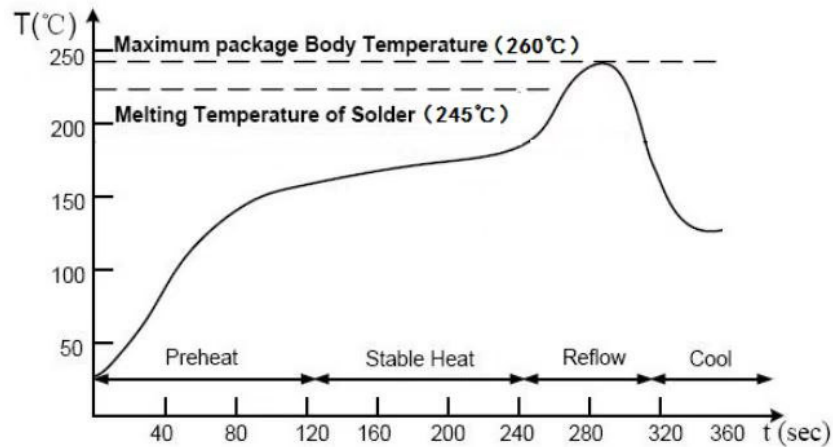


A0	B0	K0	D0	E	F
5.10	7.20	2.88	1.55	1.75	5.50
P0	P1	P2	T	W	Tolerance
4.0	8.0	2.0	0.25	12	0.1

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Lead Free Reflow Soldering Profile

Suggested Soldering Temperature Profile



Note

- Recommended reflow methods: IR, vapor phase oven, hot air oven, wave solder.
- The device can be exposed to a maximum temperature of 260°C for 10 seconds.
- Devices can be cleaned using standard industry methods and solvents.
- If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

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Stock period

The performance of these products, including the solderability, is guaranteed for 12 month, provided that they remain packed as they were when delivered and stored at a temperature of 0-35°C and a relative humidity 35-75%RH

10/19/2022

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Please read cautions and warnings and important notes at the end of this document.

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